

Ultra-Low Capacitance ESD Diode Array

- ESD / transient protection of high-speed data lines exceeding IEC61000-4-2 (ESD): 20 kV (air / contact) IEC61000-4-4 (EFT): 40 A (5/50 ns) IEC61000-4-5 (surge): 3 A (8/20 µs)
- Max. working voltage: 5.3 V
- Extremely low capacitance: down to 0.2 pF
- Very low clamping voltage: 12 V typ.
- Extremely low forward clamping voltage: 4 V typ.
- Very low reverse current: < 1 nA typ.
- Pb-free (RoHS compliant) package

Applications

- USB 2.0, 10/100/1000 Ethernet, FireWire, DVI HDMI, S-ATA
- Mobile communication
- Consumer products (STB, MP3; DVD, DSC...)
- LCD displays, camera
- Notebooks and destop computers, peripherals



ESD5V3U2U-03F ESD5V3U2U-03LRH



Туре	Package	Configuration	Marking
ESD5V3U2U-03F	TSFP-3	2 lines, uni-directional*	Z1
ESD5V3U2U-03LRH	TSLP-3-7	2 lines, uni-directional*	Z1

* or 1 line, bi-directional between pins 1 and 2, if pin 3 is not connected





Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit				
ESD contact/ air discharge ¹⁾	V _{ESD}	20	kV				
Peak pulse current ($t_p = 8 / 20 \ \mu s$) ²⁾	I _{pp}	3	A				
Operating temperature range	T _{op}	-40125	°C				
Storage temperature	T _{stg}	-65150					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
Characteristics -	·	•			
Reverse working voltage	V _{RWM}	-	-	5.3	V
Breakdown voltage	V _(BR)	6	-	-	
$I_{(BR)}$ = 1 mA, from pin 1 to 3					
Reverse current	I _R	-	< 1	50	nA
V_{R} = 5.3 V, from pin 1 to 3					
Clamping voltage	V _{CL}				V
$I_{\rm PP}$ = 1 A, $t_{\rm p}$ = 8/20µs ²⁾ , from 1/2 to 3		-	10	13	
$I_{\rm PP}$ = 3 A, $t_{\rm p}$ = 8/20µs ²⁾ , from 1/2 to 3		-	12	15	
Forward clamping voltage	V _{FC}				
$I_{\rm PP}$ = 1 A, $t_{\rm p}$ = 8/20µs ²⁾ , from 3 to 1/2		-	2	4	
$I_{\rm PP}$ = 3 A, $t_{\rm p}$ = 8/20µs ²⁾ , from 3 to 1/2		-	4	6	
Line capacitance, $V_R = 0 V$, $f = 1 MHz$	CT				pF
from pin 1/2 to $3^{3)}$		-	0.4	0.6	
from pin 1 to 2, pin 3 not connected		-	0.2	0.4	

 $^{1}V_{\text{ESD}}$ according to IEC61000-4-2

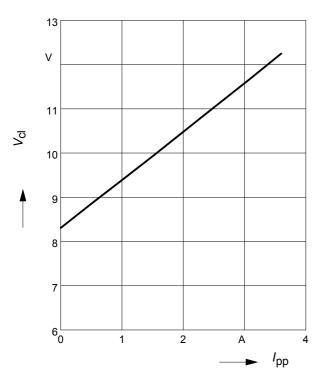
 $^2\textit{I}_{pp}$ according to IEC61000-4-5

³Total capacitance line to ground

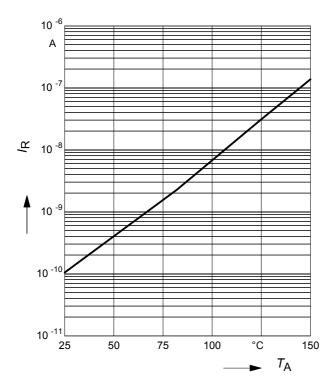


Clamping voltage, $V_{cl} = f(I_{pp})$

 $t_{\rm p}$ = 8 / 20 µs, from pin 1/2 to 3

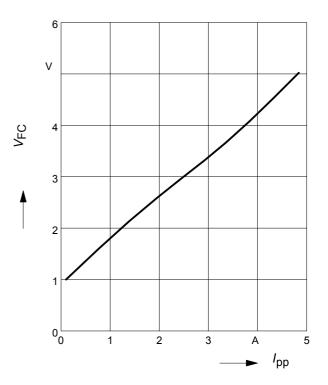


Reverse current $I_{R} = f(T_{A})$ V_{R} = Parameter, from pin 1/2 to 3

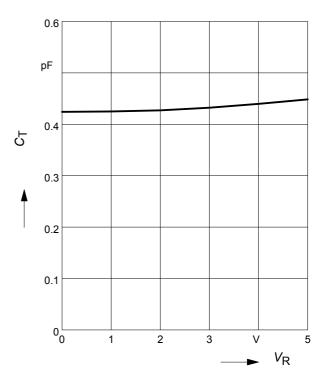


Forward clamping voltage $V_{FC} = f(I_{PP})$

 $t_{\rm p}$ = 8 / 20 µs, from pin 3 to 1/2



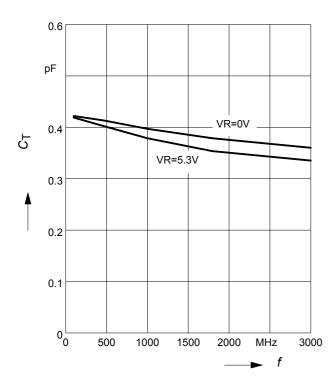
Diode capacitance $C_{T} = f(V_{R})$ f = 1MHz, from pin 1/2 to 3





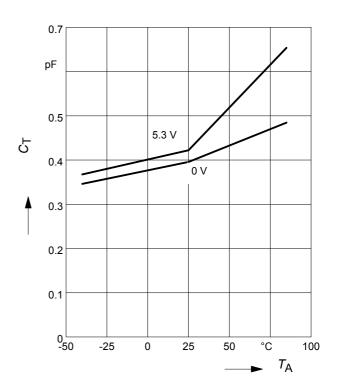
Line capacitance $C_T = f$ (f)

 V_{R} = parameter, from pin 1/2 to 3



Line capacitance $C_{T} = f(T_{A})$

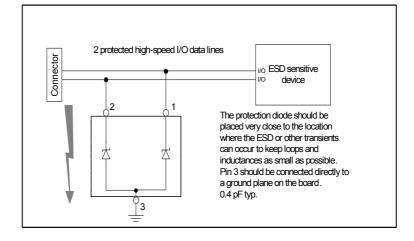
 $V_{\rm R} = 0 \, {\rm V}, \, f = 1 \, {\rm MHz}$





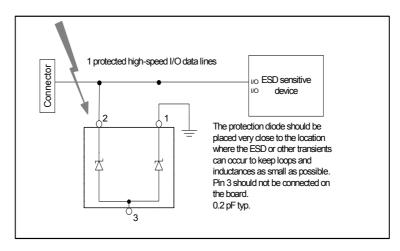
Application example ESD5V3U2U...

2 lines, uni-directional

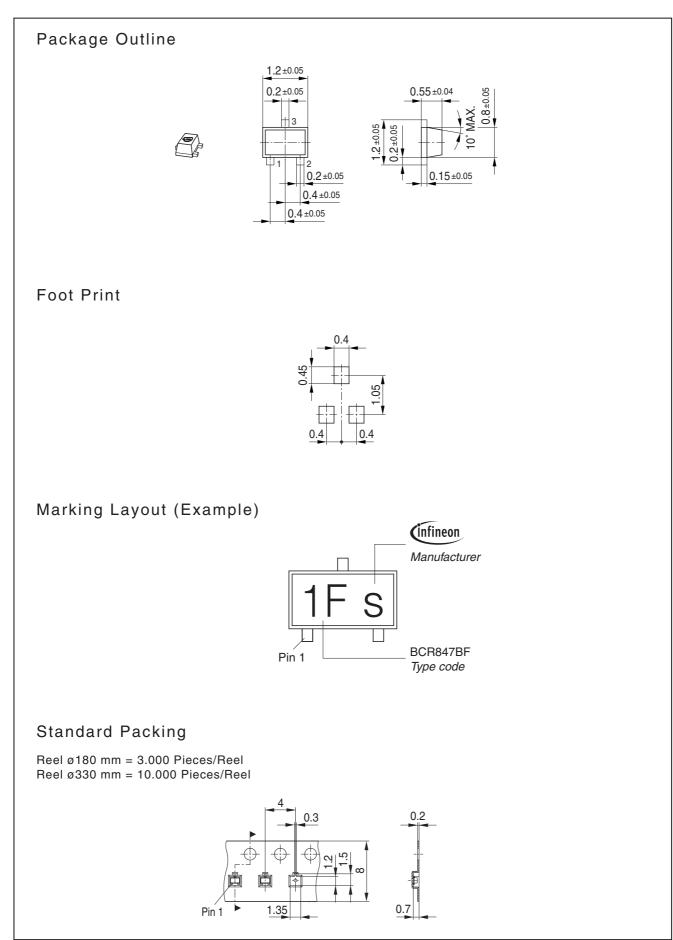


Application example ESD5V3U2U...

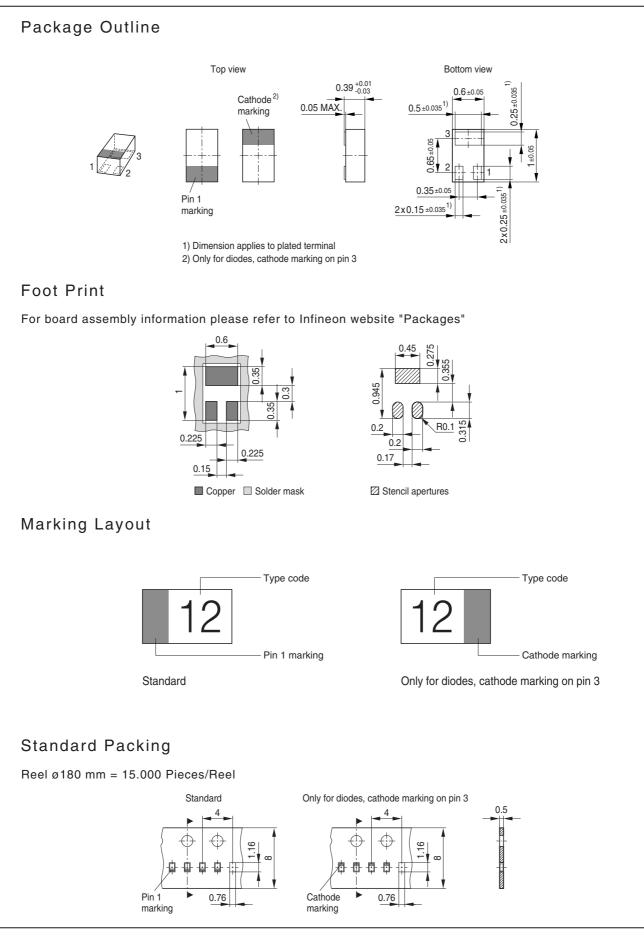
1 line, bi-directional















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